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SLOS475-AUGUST 2005

FEATURES

- Low Supply Current . . . 85 μA Typ
- Low Offset Voltage . . . 2 mV Typ
- Low Input Bias Current . . . 2 nA Typ
- Input Common Mode to GND
- Wide Supply Voltage . . . 3 V < V_{CC} < 32 V
- Pin Compatible With LM358

APPLICATIONS

- LCD Displays
- Portable Instrumentation
- Sensor/Metering Equipment
- Consumer Electronics (MP3 Players, Toys)
- Power Supplies

DESCRIPTION/ORDERING INFORMATION

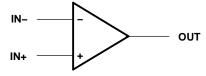
The LP358 and LP2904 are dual low-power operational amplifiers especially suited for battery-operated applications. Good input specifications and wide supply-voltage range still are achieved, despite the ultra-low supply current. Single-supply operation is achieved with an input common-mode range that includes GND.

The LP358 and LP2904 are ideal in applications where wide supply voltage and low power are more important than speed and bandwidth. These applications include portable instrumentation, LCD displays, consumer electronics (MP3 players, toys, etc.), and power supplies.

ORDERING INFORMATION

T _A	PA	CKAGE ⁽¹⁾	ORDERABLE PART NUMBER	TOP-SIDE MARKING		
0°C to 70°C	SOIC - D	Tube of 75	LP358D	LP358		
	30IC - D	Reel of 2500	LP358DR	LF330		
		Tube of 100	LP358DGK			
	VSSOP - DGK	Reel of 250	LP358DGKT	PREVIEW		
		Reel of 2500	LP358DGKR			
-40°C to 85°C	SOIC - D	Tube of 75	LP2904D	PREVIEW		
	30IC - D	Reel of 2500	LP2904DR	PREVIEW		
		Tube of 100 LP2904DGK				
	VSSOP - DGK	Reel of 250	LP2904DGKT	PREVIEW		
		Reel of 2500	LP2904DGKR			

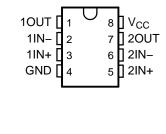
SYMBOL (EACH AMPLIFIER)



(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

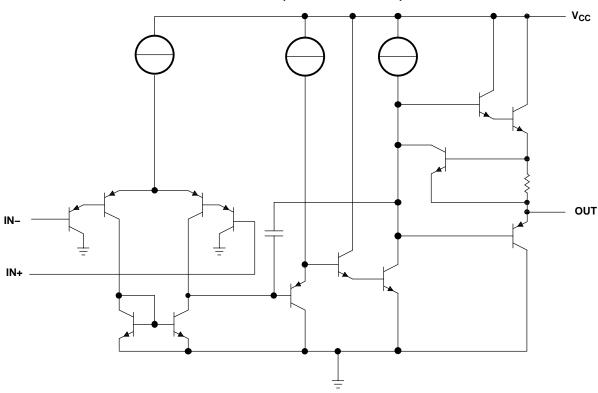


D OR DGK PACKAGE

(TOP VIEW)



SCHEMATIC (EACH AMPLIFIER)



Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT	
V_{CC}	Supply voltage range ⁽²⁾		±16 or 32	V		
V_{ID}	Differential input voltage (3)		±32	V		
VI	Input voltage (either input)	-0.3	32	V		
	Duration of output short circuit (one amplifier) to groun		Unlimited			
θ_{JA}	Deckers thermal impedance (5) (6)	D package		97	°C/W	
	Package thermal impedance (5) (6) DGK package			172	-C/VV	
TJ	Operating virtual junction temperature			150	°C	
T _{stg}	Storage temperature range			150	°C	

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values (except differential voltages and V_{CC} specified for the measurement of I_{OS}) are with respect to the network GND.
- (3) Differential voltages are at IN+, with respect to IN-.
- 4) Short circuits from outputs to V_{CC} can cause excessive heating and eventual destruction.
- (5) Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
- (6) The package thermal impedance is calculated in accordance with JESD 51-7.

ESD Protection

TEST CONDITIONS	TYP	UNIT
Human-Body Model	±2	kV

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Electrical Characteristics

 $\rm T_A$ = 25°C, $\rm V_{CC}$ = 5 V, $\rm V_{IC}$ = V $_{CC}$ /2, $\rm R_L$ = 100 k Ω to GND (unless otherwise noted)

PARAMETER		TEST CONDITIONS(1)	T (2)	L	_P358		LP2904			UNIT
	PARAMETER	TEST CONDITIONS ⁽¹⁾	T _A ⁽²⁾	MIN	TYP ⁽³⁾	MAX	MIN	TYP ⁽³⁾	MAX	UNII
V	Innut offeet valtage		25°C		2	4		2	4	m)/
V_{IO}	Input offset voltage		Full range			9			10	mV
_	Input bigg gurrent		25°C		2	10		2	20	nA
I _{IB}	Input bias current		Full range			20			40	ΠA
-	Innut offeet ourrent		25°C		0.2	2		0.5	4	nA
I _{IO}	Input offset current		Full range			4			8	IIA
۸	Large-signal	$R_L = 10 \text{ k}\Omega \text{ to GND},$	25°C	50	100		40	70		V/mV
A_V	voltage gain	$V_{CC} = 30 \text{ V}$	Full range	40			30			V/IIIV
CMRR	Common-mode	V _{CC} = 30 V,	25°C	80	90		80	90		dB
CIVIKK	rejection ratio	$V_{IC} = 0 \text{ V to } V_{CC} - 1.5 \text{ V}$	Full range	75			75			uБ
1-	Power-supply	V 5.V to 20.V	25°C	80	90		80	90		
k _{VSR}	rejection ratio	$V_{CC} = 5 \text{ V to } 30 \text{ V}$	Full range	75			75			V
-		D	25°C		85	150		85	150	μА
I _{CC}	Supply current	R _L = ∞	Full range			250			275	
V	Output voltage	$I_L = 0.35$ mA to GND, $V_{IC} = 0$ V	25°C	3.4	3.6		3.4	3.6		V
V _{OH}	swing (high)		Full range	V _{CC} – 1.9			V _{CC} - 1.9			
V	Output voltage	$I_L = 0.35 \text{ mA from } V_{CC}$	25°C	0.82	0.7		0.82	0.7		V
V_{OL}	swing (low)	$V_{IC} = 0 \text{ V}$	Full range	1			1			
_	Output source	$V_O = 3 \text{ V}, V_{ID} = 1 \text{ V}$	25°C	7	10		7	10		mA
I _O	current		Full range	4			4			
		V 45V V 4V	25°C	4	5		4	5		
	Output sink surrent	$V_{O} = 1.5 \text{ V}, V_{ID} = -1 \text{ V}$	Full range	3			3			A
I _O	Output sink current	$V_{O} = 1.5 \text{ V}, V_{ID} = -1 \text{ V},$	25°C	2	4		2	4		mA
		$V_{IC} = 0 V$	Full range	1			1			ı
-	Output about to CND	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	25°C		20	35		20	35	
los,gnd	Output short to GND	V _{ID} = 1 V	Full range			40			40	mA
I Outrout als art to M	V 4.V	25°C		15	30		15	30	A	
l _{os,vcc}	Output short to V _{CC}	$V_{ID} = -1 V$	Full range			45			45	mA
αV_{IO}	Input offset voltage drift		25°C		10			10		μV/°C
αI_{IO}	Input offset current drift		25°C		10			10		pA/°C

⁽¹⁾ For full-range temperature limits: $V_{CC} = 3$ V to 32 V, $V_{ICR} = 0$ V to $V_{CC} - 1.5$ V (unless otherwise noted) (2) Full range is 0°C to 70°C for LP358 and -40°C to 85°C for LP2904. (3) All typical values are at $T_A = 25$ °C.

Operating Conditions

 $V_{CC} = \pm 15 \text{ V}, T_A = 25^{\circ}\text{C}$

00	A		
	PARAMETER	TYP	UNIT
GBW	Gain bandwidth product	100	kHz
SR	Slew rate	50	V/ms





ti.com 23-Sep-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
LP358D	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LP358DE4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LP358DR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LP358DRE4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

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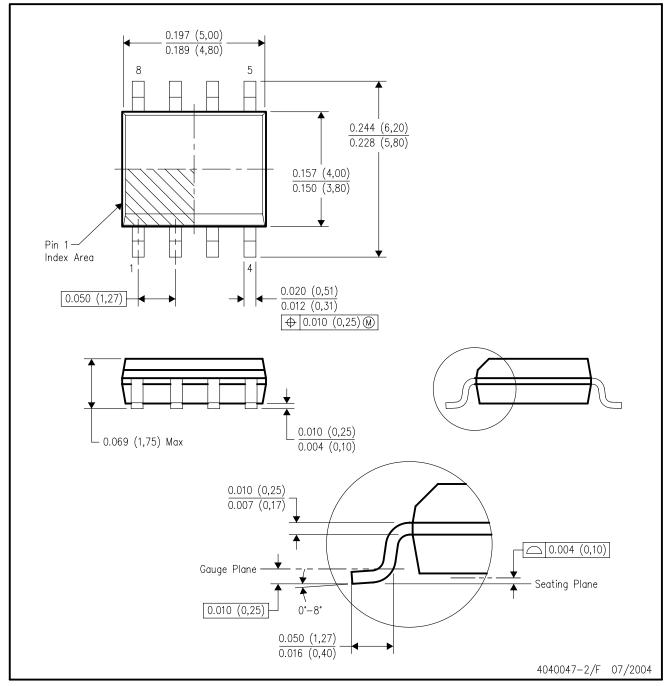
(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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D (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AA.



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